



SEMIPACK®

Fast Diode Modules

SKKE800F17

Features*

- CAL4 = Soft switching 4. Generation CAL-Diode
- Heat transfer through aluminum oxide DCB ceramic insulated metal baseplate
- Small recovery charge
- UL recognized, file no. E63532

Typical Applications

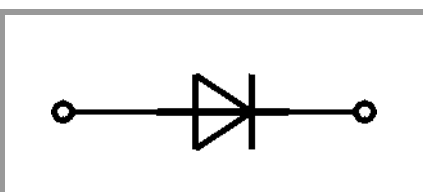
- Freewheeling diodes for IGBT
- Freewheeling diode for inductive loads
- Brake choppers
- Inverters and DC choppers
- AC motor control
- Boost choppers

Remarks

- Case temperature limited to $T_c = 125^\circ\text{C}$ max.
- Recommended $T_{j,op} = -40 \dots +150^\circ\text{C}$
- Product reliability results valid for $T_j = 150^\circ\text{C}$

Absolute Maximum Ratings				
Symbol	Conditions		Values	Unit
Diode				
V _{RRM}	T _j = 25 °C		1700	V
I _F	T _j = 175 °C	T _c = 25 °C	953	A
		T _c = 100 °C	601	A
I _{FRM}			1600	A
I _{FSM}	10 ms	T _j = 25 °C	4160	A
		T _j = 150 °C	3712	A
i ² t	10 ms	T _j = 25 °C	86528	A ² s
		T _j = 150 °C	68895	A ² s
T _j			-40 ... 175	°C
Module				
T _{stg}			-40 ... 125	°C
V _{isol}	a.c.; 50 Hz; r.m.s.	1 min	4000	V
		1 s	4800	V

Characteristics						
Symbol	Conditions		min.	typ.	max.	Unit
Diode						
V _F	I _F = 800 A	T _j = 25 °C		2.00	2.40	V
	chiplevel	T _j = 150 °C		2.15	2.57	V
V _{F0}	chiplevel	T _j = 25 °C		1.32	1.56	V
		T _j = 150 °C		1.08	1.22	V
r _F	chiplevel	T _j = 25 °C		0.86	1.05	mΩ
		T _j = 150 °C		1.34	1.69	mΩ
I _R	V _R = V _{RRM}	T _j = 25 °C			0.68	mA
		T _j = 150 °C			200	mA
Q _{rr}	I _F = 800 A di/dt _{off} = 4000 A/μs V _R = 1200 V	T _j = 150 °C		210		μC
I _{RRM}		T _j = 150 °C		400		A
t _{rr}		T _j = 150 °C		1.2		μs
E _{rr}		T _j = 150 °C		140		mJ
R _{th(j-c)}	per diode				0.058	K/W
R _{th(c-s)}	per diode/module (λ _{grease} =0.81 W/(m²K))			0.045		K/W
R _{th(c-s)}	per diode/module, pre-applied phase change material			-		K/W
Module						
L _{CE}				15		nH
R _{CC'+EE'}	measured per switch	T _C = 25 °C		0.23		mΩ
		T _C = 125 °C		0.3		mΩ
M _s	to heat sink M6		3		5	Nm
M _t	to terminals M6		2.5		5	Nm
a					5 * 9.81	m/s²
w				330		g



SKKE

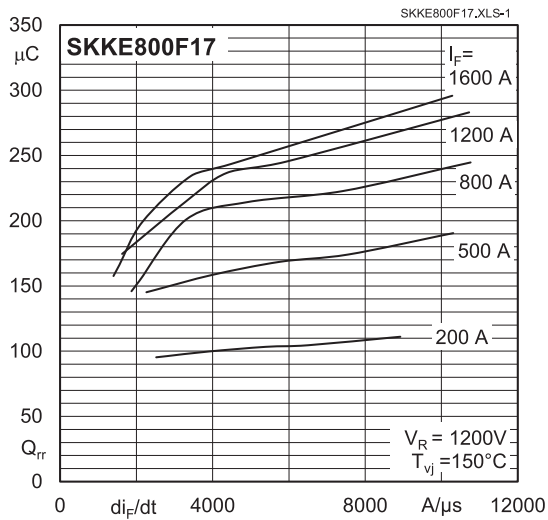


Fig. 1: Typ. recovery charge vs. current decrease

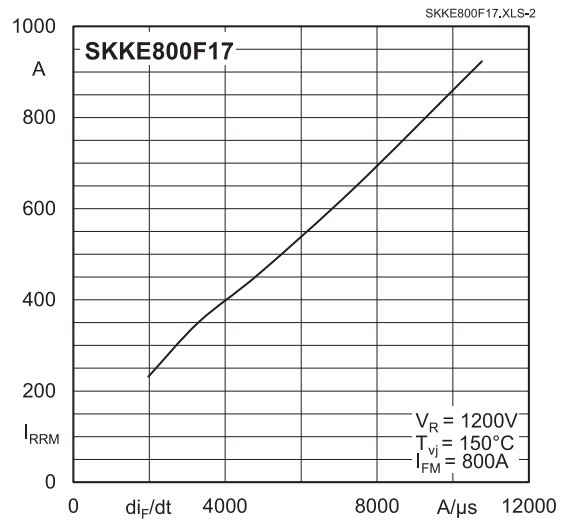


Fig. 2: Peak recovery current vs. current decrease

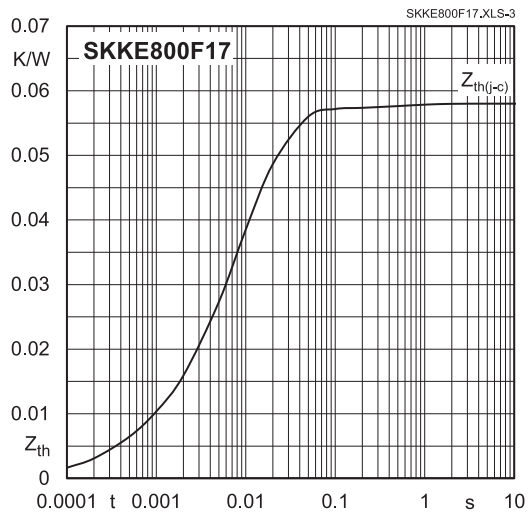


Fig. 3: Transient thermal impedance vs. time

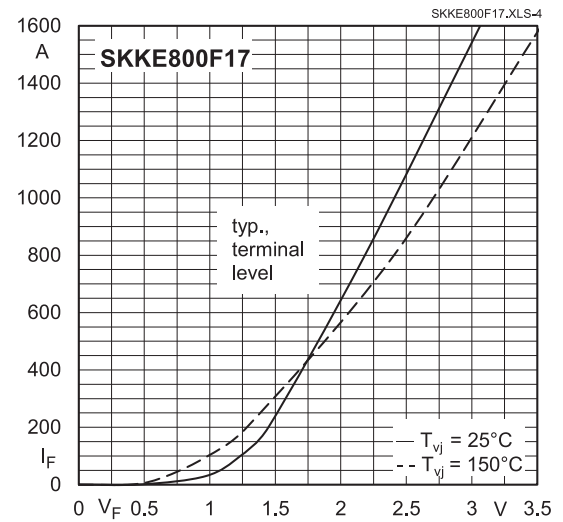


Fig. 4: Forward characteristics

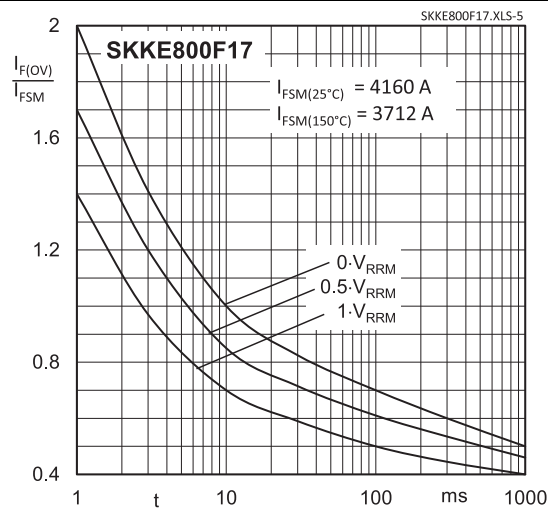


Fig. 5: Surge overload current vs. time

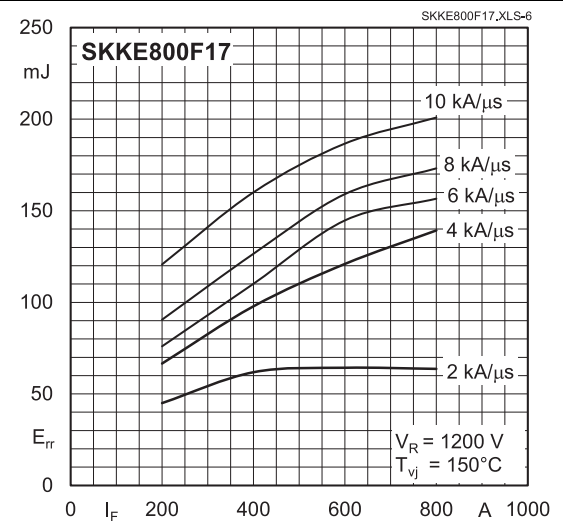


Fig. 6: Typ. turn-off energy dissipation per pulse

This is an electrostatic discharge sensitive device (ESDS) due to international standard IEC 61340.

***IMPORTANT INFORMATION AND WARNINGS**

The specifications of SEMIKRON products may not be considered as guarantee or assurance of product characteristics ("Beschaffenheitsgarantie"). The specifications of SEMIKRON products describe only the usual characteristics of products to be expected in typical applications, which may still vary depending on the specific application. Therefore, products must be tested for the respective application in advance. Application adjustments may be necessary. The user of SEMIKRON products is responsible for the safety of their applications embedding SEMIKRON products and must take adequate safety measures to prevent the applications from causing a physical injury, fire or other problem if any of SEMIKRON products become faulty. The user is responsible to make sure that the application design is compliant with all applicable laws, regulations, norms and standards. Except as otherwise explicitly approved by SEMIKRON in a written document signed by authorized representatives of SEMIKRON, SEMIKRON products may not be used in any applications where a failure of the product or any consequences of the use thereof can reasonably be expected to result in personal injury. No representation or warranty is given and no liability is assumed with respect to the accuracy, completeness and/or use of any information herein, including without limitation, warranties of non-infringement of intellectual property rights of any third party. SEMIKRON does not assume any liability arising out of the applications or use of any product; neither does it convey any license under its patent rights, copyrights, trade secrets or other intellectual property rights, nor the rights of others. SEMIKRON makes no representation or warranty of non-infringement or alleged non-infringement of intellectual property rights of any third party which may arise from applications. Due to technical requirements our products may contain dangerous substances. For information on the types in question please contact the nearest SEMIKRON sales office. This document supersedes and replaces all information previously supplied and may be superseded by updates. SEMIKRON reserves the right to make changes.